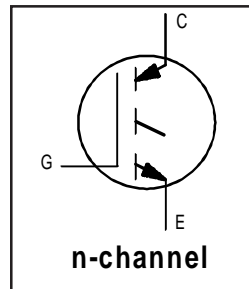


# IRG4PF50W

## INSULATED GATE BIPOLAR TRANSISTOR

### Features

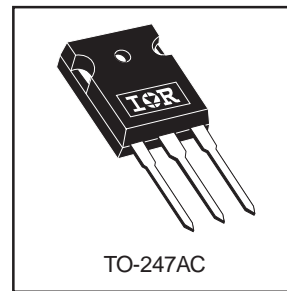
- Optimized for use in Welding and Switch-Mode Power Supply applications
- Industry benchmark switching losses improve efficiency of all power supply topologies
- 50% reduction of E<sub>off</sub> parameter
- Low IGBT conduction losses
- Latest technology IGBT design offers tighter parameter distribution coupled with exceptional reliability



|                                   |
|-----------------------------------|
| $V_{CES} = 900V$                  |
| $V_{CE(on)} \text{ typ.} = 2.25V$ |
| @ $V_{GE} = 15V, I_C = 28A$       |

### Benefits

- Lower switching losses allow more cost-effective operation and hence efficient replacement of larger-die MOSFETs up to 100kHz
- Of particular benefit in single-ended converters and Power Supplies 150W and higher
- Reduction in critical E<sub>off</sub> parameter due to minimal minority-carrier recombination coupled with low on-state losses allow maximum flexibility in device application



### Absolute Maximum Ratings

|                           | Parameter                              | Max.                              | Units |
|---------------------------|--|-----------------------------------|-------|
| $V_{CES}$                 | Collector-to-Emitter Breakdown Voltage | 900                               | V     |
| $I_C @ T_C = 25^\circ C$  | Continuous Collector Current           | 51                                | A     |
| $I_C @ T_C = 100^\circ C$ | Continuous Collector Current           | 28                                |       |
| $I_{CM}$                  | Pulsed Collector Current ①             | 204                               |       |
| $I_{LM}$                  | Clamped Inductive Load Current ②       | 204                               |       |
| $V_{GE}$                  | Gate-to-Emitter Voltage                | $\pm 20$                          | V     |
| $E_{ARV}$                 | Reverse Voltage Avalanche Energy ③     | 186                               | mJ    |
| $P_D @ T_C = 25^\circ C$  | Maximum Power Dissipation              | 200                               | W     |
| $P_D @ T_C = 100^\circ C$ | Maximum Power Dissipation              | 78                                |       |
| $T_J$                     | Operating Junction and                 | -55 to + 150                      | °C    |
| $T_{STG}$                 | Storage Temperature Range              |                                   |       |
|                           | Soldering Temperature, for 10 seconds  | 300 (0.063 in. (1.6mm from case ) |       |

### Thermal Resistance

|                 | Parameter                                 | Typ.     | Max. | Units  |
|-----------------|---|----------|------|--------|
| $R_{\theta JC}$ | Junction-to-Case                          | —        | 0.64 | °C/W   |
| $R_{\theta CS}$ | Case-to-Sink, Flat, Greased Surface       | 0.24     | —    |        |
| $R_{\theta JA}$ | Junction-to-Ambient, typical socket mount | —        | 40   |        |
| Wt              | Weight                                    | 6 (0.21) | —    | g (oz) |

## Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

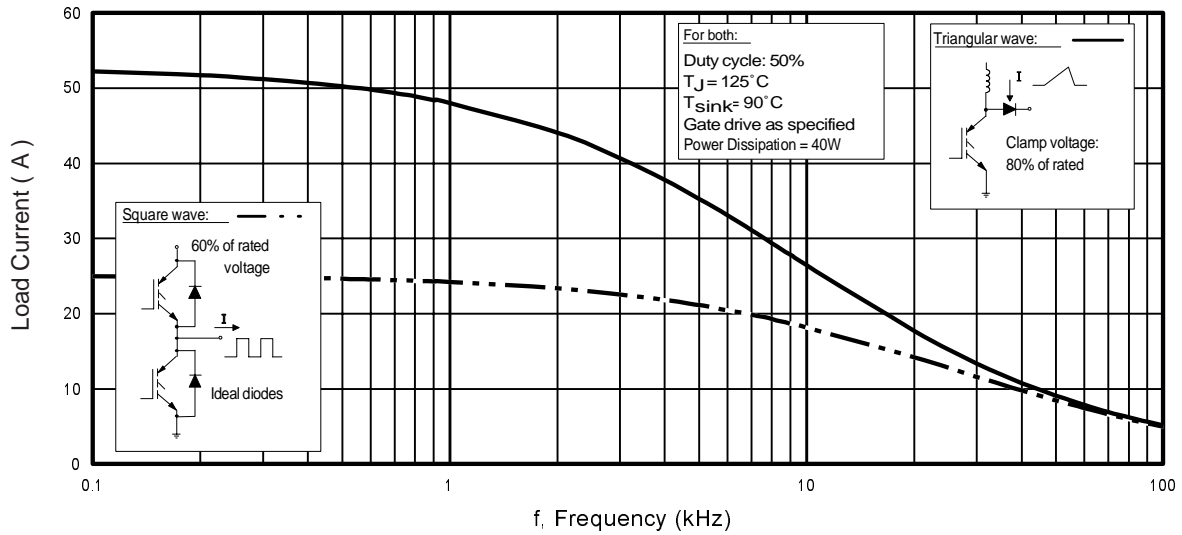
|                                 | Parameter                                | Min. | Typ.  | Max.      | Units   | Conditions  |
|---------------------------------|--|------|-------|-----------|---------|---|
| $V_{(BR)CES}$                   | Collector-to-Emitter Breakdown Voltage   | 900  | —     | —         | V       | $V_{GE} = 0V, I_C = 250\mu A$   |
| $V_{(BR)ECS}$                   | Emitter-to-Collector Breakdown Voltage ④ | 18   | —     | —         | V       | $V_{GE} = 0V, I_C = 1.0A$   |
| $\Delta V_{(BR)CES}/\Delta T_J$ | Temperature Coeff. of Breakdown Voltage  | —    | 0.295 | —         | V/°C    | $V_{GE} = 0V, I_C = 3.5mA$  |
| $V_{CE(ON)}$                    | Collector-to-Emitter Saturation Voltage  | —    | 2.25  | 2.7       | V       | $I_C = 28A$<br>$I_C = 60A$<br>$I_C = 28A, T_J = 150^\circ\text{C}$<br>$V_{CE} = V_{GE}, I_C = 250\mu A$ |
|                                 |  | —    | 2.74  | —         |         |   |
|                                 |  | —    | 2.12  | —         |         |   |
| $V_{GE(th)}$                    | Gate Threshold Voltage                   | 3.0  | —     | 6.0       | mV/°C   | $V_{CE} = V_{GE}, I_C = 1.0mA$  |
| $\Delta V_{GE(th)}/\Delta T_J$  | Temperature Coeff. of Threshold Voltage  | —    | -13   | —         | mV/°C   | $V_{CE} = V_{GE}, I_C = 1.0mA$  |
| $g_{fe}$                        | Forward Transconductance ⑤               | 26   | 39    | —         | S       | $V_{CE} \geq 15V, I_C = 28A$  |
| $I_{CES}$                       | Zero Gate Voltage Collector Current      | —    | —     | 500       | $\mu A$ | $V_{GE} = 0V, V_{CE} = 900V$  |
|                                 |  | —    | —     | 2.0       |         | $V_{GE} = 0V, V_{CE} = 10V, T_J = 25^\circ\text{C}$   |
|                                 |  | —    | —     | 5.0       | mA      | $V_{GE} = 0V, V_{CE} = 900V, T_J = 150^\circ\text{C}$   |
| $I_{GES}$                       | Gate-to-Emitter Leakage Current          | —    | —     | $\pm 100$ | nA      | $V_{GE} = \pm 20V$  |

## Switching Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

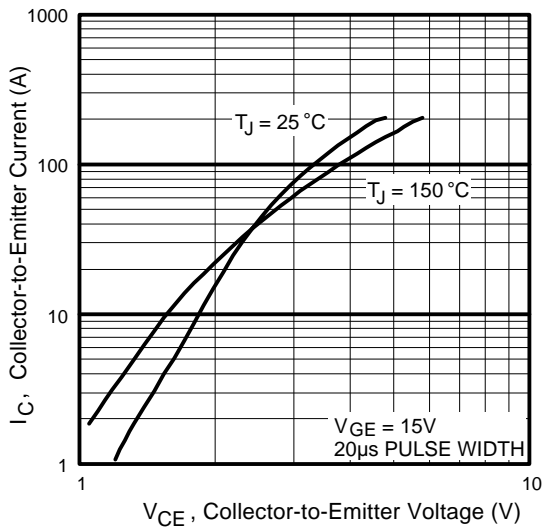
|              | Parameter                         | Min. | Typ. | Max. | Units | Conditions   |
|--------------|-----------------------------------|------|------|------|-------|--|
| $Q_g$        | Total Gate Charge (turn-on)       | —    | 160  | 240  | nC    | $I_C = 28A$<br>$V_{CC} = 400V$<br>$V_{GE} = 15V$<br>See Fig. 8   |
| $Q_{ge}$     | Gate - Emitter Charge (turn-on)   | —    | 19   | 29   |       |  |
| $Q_{gc}$     | Gate - Collector Charge (turn-on) | —    | 53   | 80   |       |  |
| $t_{d(on)}$  | Turn-On Delay Time                | —    | 29   | —    | ns    | $T_J = 25^\circ\text{C}$<br>$I_C = 28A, V_{CC} = 720V$<br>$V_{GE} = 15V, R_G = 5.0\Omega$<br>Energy losses include "tail"<br>See Fig. 10, 11, 13, 14 |
| $t_r$        | Rise Time                         | —    | 26   | —    |       |  |
| $t_{d(off)}$ | Turn-Off Delay Time               | —    | 110  | 170  |       |  |
| $t_f$        | Fall Time                         | —    | 150  | 220  |       |  |
| $E_{on}$     | Turn-On Switching Loss            | —    | 0.19 | —    | mJ    | See Fig. 10, 11, 13, 14  |
| $E_{off}$    | Turn-Off Switching Loss           | —    | 1.06 | —    |       |  |
| $E_{ts}$     | Total Switching Loss              | —    | 1.25 | 1.7  | ns    | $T_J = 150^\circ\text{C},$<br>$I_C = 28A, V_{CC} = 720V$<br>$V_{GE} = 15V, R_G = 5.0\Omega$<br>Energy losses include "tail"<br>See Fig. 13, 14       |
| $t_{d(on)}$  | Turn-On Delay Time                | —    | 28   | —    |       |  |
| $t_r$        | Rise Time                         | —    | 26   | —    |       |  |
| $t_{d(off)}$ | Turn-Off Delay Time               | —    | 280  | —    |       |  |
| $t_f$        | Fall Time                         | —    | 90   | —    | mJ    | See Fig. 13, 14  |
| $E_{ts}$     | Total Switching Loss              | —    | 3.45 | —    |       |  |
| $L_E$        | Internal Emitter Inductance       | —    | 13   | —    | nH    | Measured 5mm from package  |
| $C_{ies}$    | Input Capacitance                 | —    | 3300 | —    | pF    | $V_{GE} = 0V$<br>$V_{CC} = 30V$<br>$f = 1.0MHz$<br>See Fig. 7  |
| $C_{oes}$    | Output Capacitance                | —    | 200  | —    |       |  |
| $C_{res}$    | Reverse Transfer Capacitance      | —    | 45   | —    |       |  |

### Notes:

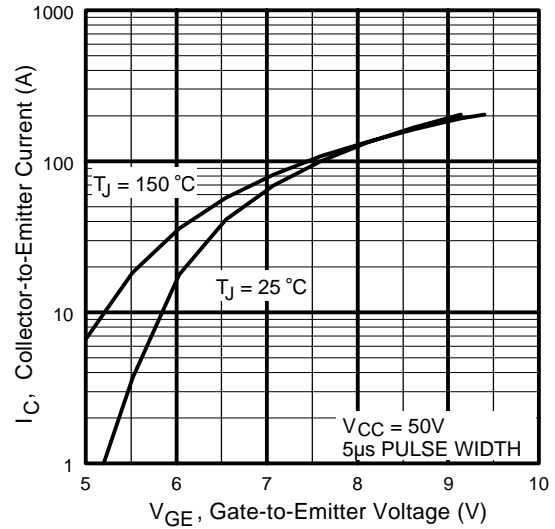
- ① Repetitive rating;  $V_{GE} = 20V$ , pulse width limited by max. junction temperature. ( See fig. 13b )
- ②  $V_{CC} = 80\%(V_{CES}), V_{GE} = 20V, L = 10\mu H, R_G = 5.0\Omega,$  (See fig. 13a)
- ③ Repetitive rating; pulse width limited by maximum junction temperature.
- ④ Pulse width  $\leq 80\mu s$ ; duty factor  $\leq 0.1\%$ .
- ⑤ Pulse width  $5.0\mu s$ , single shot.



**Fig. 1 - Typical Load Current vs. Frequency**  
(For square wave,  $I=I_{RMS}$  of fundamental; for triangular wave,  $I=I_{PK}$ )



**Fig. 2 - Typical Output Characteristics**



**Fig. 3 - Typical Transfer Characteristics**

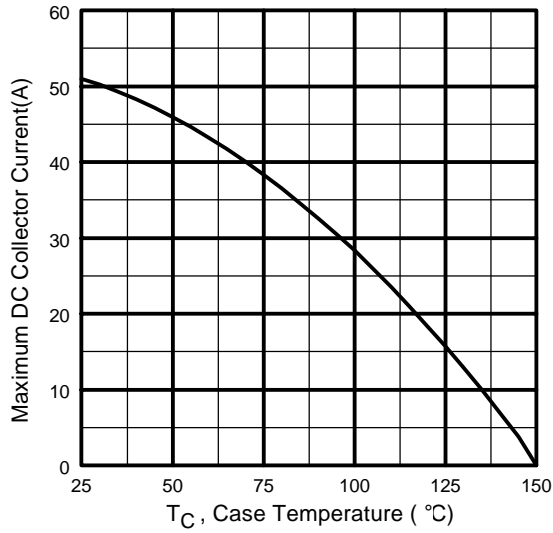


Fig. 4 - Maximum Collector Current vs. Case Temperature

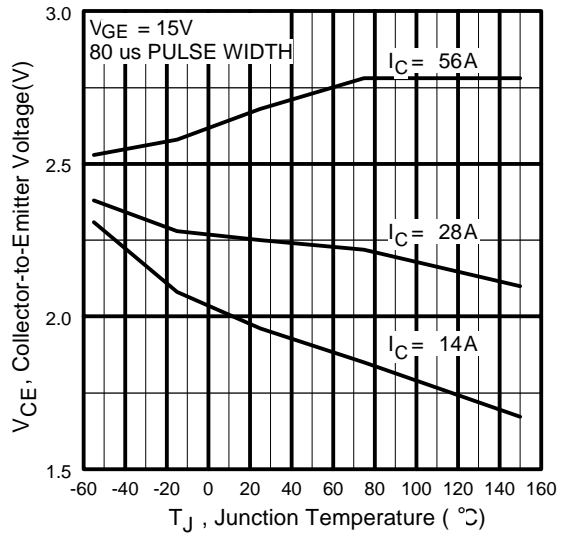


Fig. 5 - Collector-to-Emitter Voltage vs. Junction Temperature

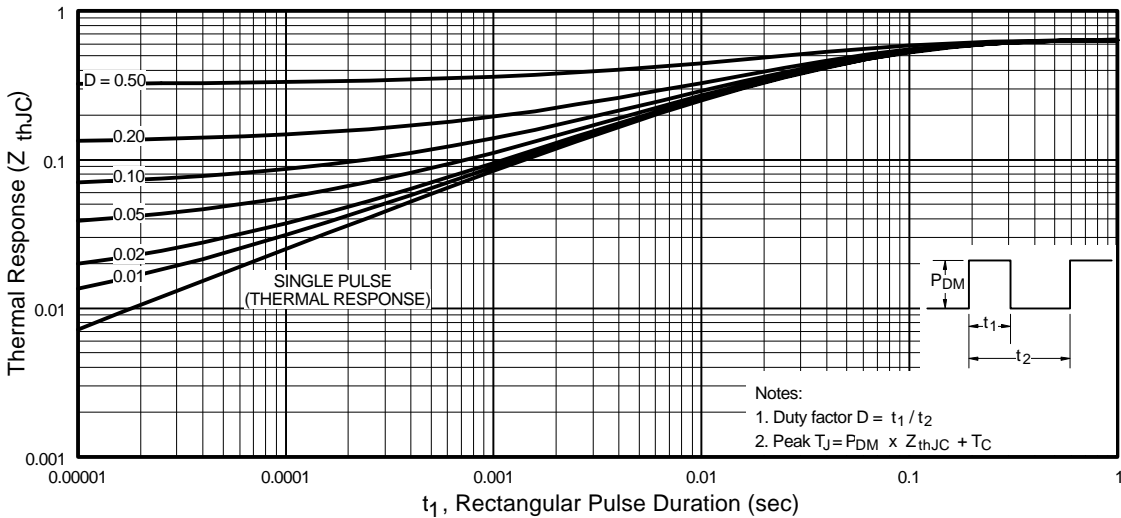


Fig. 6 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

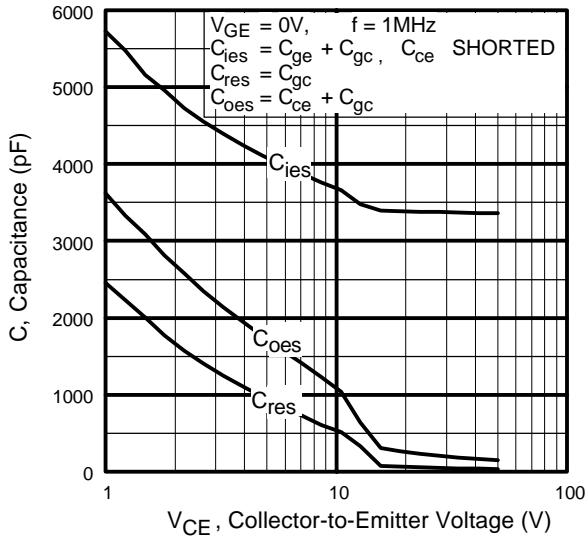


Fig. 7 - Typical Capacitance vs. Collector-to-Emitter Voltage

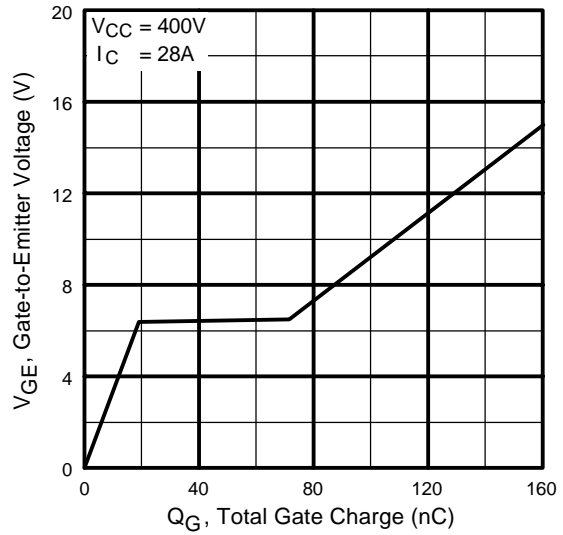


Fig. 8 - Typical Gate Charge vs. Gate-to-Emitter Voltage

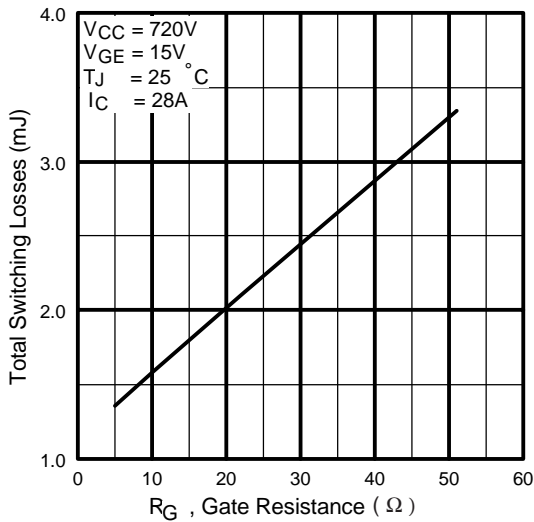


Fig. 9 - Typical Switching Losses vs. Gate Resistance

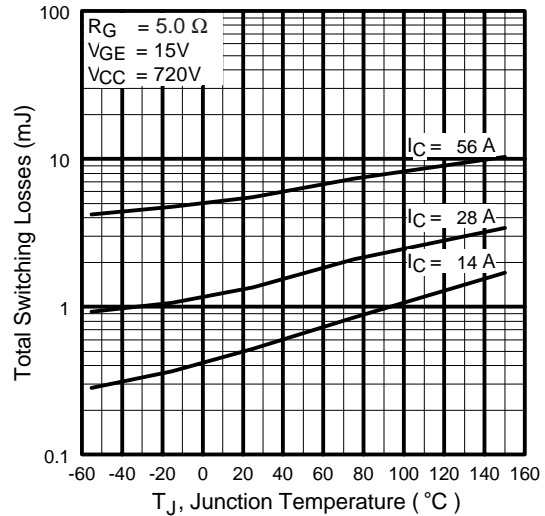
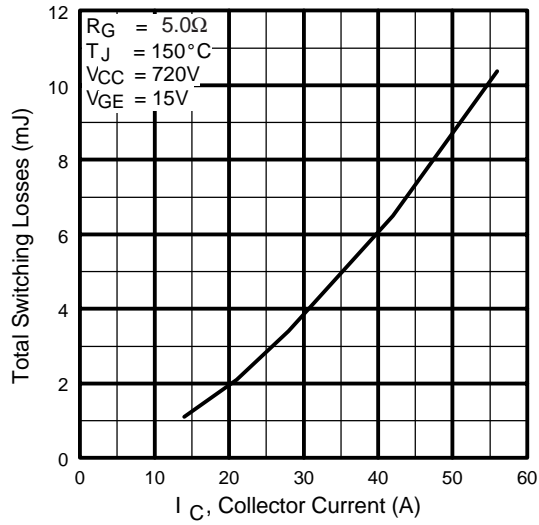
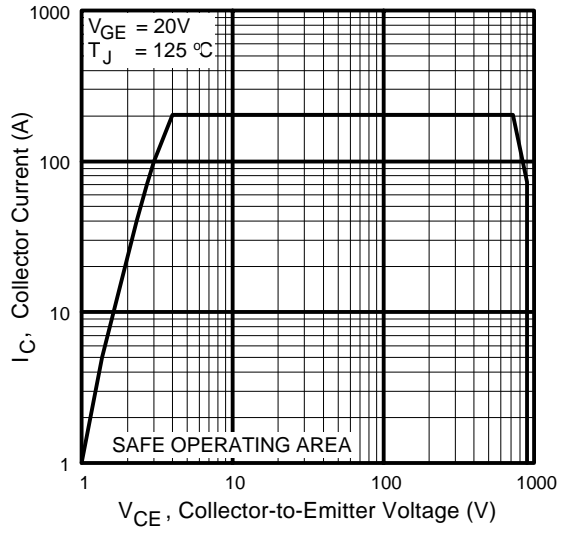


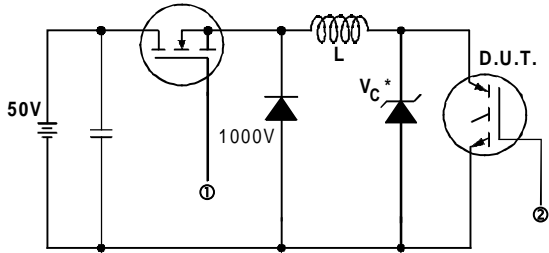
Fig. 10 - Typical Switching Losses vs. Junction Temperature



**Fig. 11** - Typical Switching Losses vs. Collector-to-Emitter Current

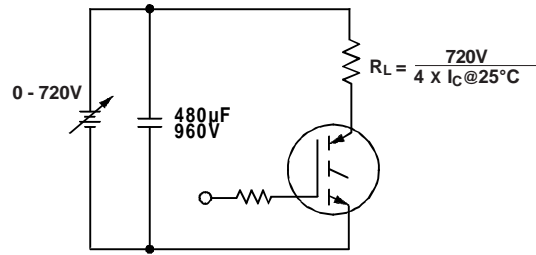


**Fig. 12** - Turn-Off SOA



\* Driver same type as D.U.T.;  $V_c = 80\%$  of  $V_{ce(max)}$   
 \* Note: Due to the 50V power supply, pulse width and inductor will increase to obtain rated  $I_d$ .

**Fig. 13a** - Clamped Inductive Load Test Circuit

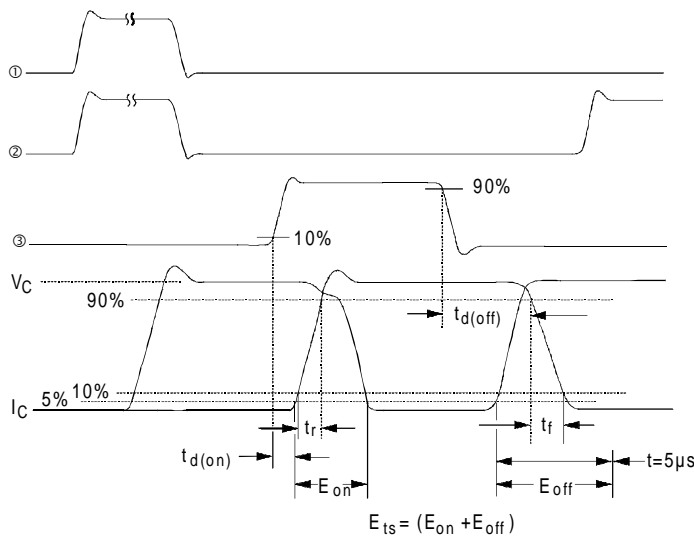


**Fig. 13b** - Pulsed Collector Current Test Circuit



**Fig. 14a** - Switching Loss Test Circuit

\* Driver same type as D.U.T.,  $V_C = 720V$

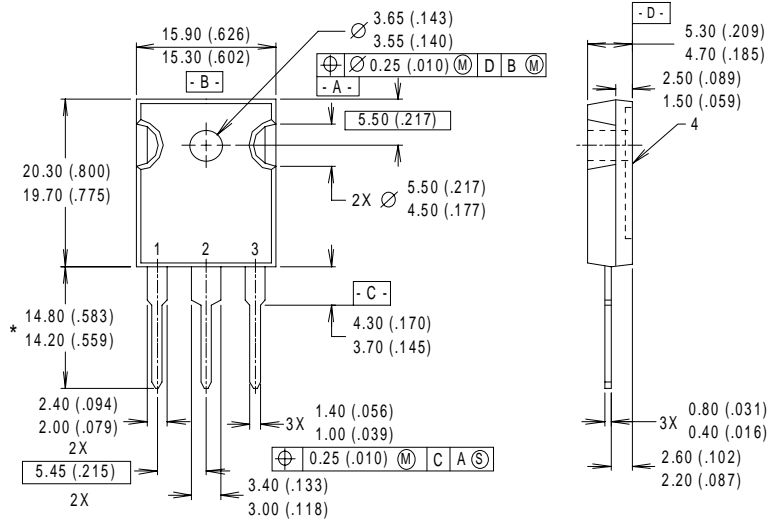


**Fig. 14b** - Switching Loss Waveforms

# IRG4PF50W

International  
**IR** Rectifier

## Case Outline and Dimensions — TO-247AC



- NOTES:
- 1 DIMENSIONS & TOLERANCING PER ANSI Y14.5M, 1982.
  - 2 CONTROLLING DIMENSION : INCH.
  - 3 DIMENSIONS ARE SHOWN MILLIMETERS (INCHES).
  - 4 CONFORMS TO JEDEC OUTLINE TO-247AC.

- LEAD ASSIGNMENTS
- 1 - GATE
  - 2 - COLLECTOR
  - 3 - EMITTER
  - 4 - COLLECTOR

\* LONGER LEADED (20mm) VERSION AVAILABLE (TO-247AD) TO ORDER ADD "-E" SUFFIX TO PART NUMBER

**CONFORMS TO JEDEC OUTLINE TO-247AC (TO-3P)**  
Dimensions in Millimeters and (Inches)

International  
**IR** Rectifier

**WORLD HEADQUARTERS:** 233 Kansas St., El Segundo, California 90245, Tel: (310) 322 3331  
**EUROPEAN HEADQUARTERS:** Hurst Green, Oxted, Surrey RH8 9BB, UK Tel: ++ 44 1883 732020  
**IR CANADA:** 15 Lincoln Court, Brampton, Ontario L6T 3Z2, Tel: (905) 453 2200  
**IR GERMANY:** Saalburgstrasse 157, 61350 Bad Homburg Tel: ++ 49 6172 96590  
**IR ITALY:** Via Liguria 49, 10071 Borgaro, Torino Tel: ++ 39 11 451 0111  
**IR FAR EAST:** 171 (K&H Bldg.) 30-4 Nishi-ikebukuro 3-chome, Toshima-ku, Tokyo Japan Tel: 81 33 983 0086  
**IR SOUTHEAST ASIA:** 315 Outram Road, #10-02 Tan Boon Liat Building, Singapore 16907 Tel: 65 221 8371  
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